

KEMET Part Number: C0603X222K2GECTU
(C0603X222K2GEC7867)

ESD SMD Comm COG, Ceramic, 2200 pF, 10%, 200 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0603



Dimensions

Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.15mm
S	0.58mm MIN
B	0.45mm +/-0.15mm

Packaging Specifications

Packaging:	T&R, 180mm, Paper Tape
Packaging Quantity:	4000

General Information

Series:	ESD SMD Comm COG
Style:	SMD Chip
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features:	Temperature Stable, Low ESR, Class I
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	4600 ug
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	2200 pF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	10%
Voltage DC:	200 VDC
ESD Level per AEC-Q200:	12,000 V ESD Level
Dielectric Withstanding Voltage:	500 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms